

SINGLE SIDED	
CERTIFICATION	UL: /ISO 9001 / ISO 14001 / TS 16949
BASE MATERIALS	FR1/FR2/CEM-3/FR-4/FR-4 Tg170°C
SURFACE FINISHES	HAL Lead-Free HAL Gold Plating OSP ENIG
TECHNICAL CAPABILITY	PCB Thickness : 0.2 to 2.4mm Min Line Width/Space (2L) : 0.10mm Min Line Width/Space (4-6L) : 0.13mm Min Hole Size : 0.25mm (PTH)